

# 50 V, 100 mA NPN general-purpose transistors Rev. 1 — 26 March 2012

**Product data sheet** 

## 1. Product profile

### 1.1 General description

NPN general-purpose transistors in a leadless ultra small DFN1006B-3 (SOT883B) Surface-Mounted Device (SMD) plastic package.

Table 1. **Product overview** 

Type number	Package			PNP complement
	Nexperia	JEITA	JEDEC	
2PC4617QMB	SOT883B	-	-	2PA1774QMB
2PC4617RMB	SOT883B	-	-	2PA1774RMB

#### 1.2 Features and benefits

- Leadless ultra small SMD plastic package
- Low package height of 0.37 mm
- Power dissipation comparable to SOT23
- AEC-Q101 qualified

### 1.3 Applications

- General-purpose switching and amplification
- Mobile applications

#### 1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{CEO}}$	collector-emitter voltage	open base	-	-	50	V
I <sub>C</sub>	collector current		-	-	100	mΑ
h <sub>FE</sub>	DC current gain	$V_{CE} = 6 \text{ V}; I_{C} = 1 \text{ mA}$				
	2PC4617QMB		120	-	270	
	2PC4617RMB		180	-	390	



## 2. Pinning information

Table 3. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter	1 3	3 
3	collector	2 🔲	1—
		Transparent top view	2
		top view	sym021

## 3. Ordering information

Table 4. Ordering information

Type number	Package				
	Name	Description	Version		
2PC4617xMB series	DFN1006B-3	leadless ultra small plastic package; 3 solder lands; body $1.0 \times 0.6 \times 0.37$ mm	SOT883B		

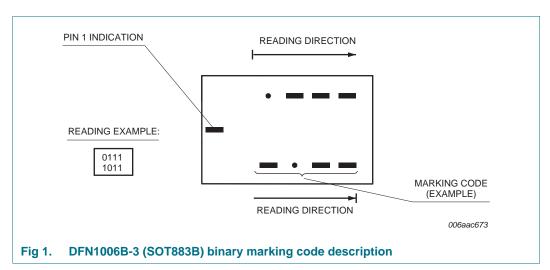
## 4. Marking

Table 5. Marking codes

Type number	Marking code <sup>[1]</sup>
2PC4617QMB	0000 1111
2PC4617RMB	0001 0000

[1] For DFN1006B-3 (SOT883B) binary marking code description see Figure 1.

## 4.1 Binary marking code description



## 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter		-	50	V
$V_{CEO}$	collector-emitter voltage	open base		-	50	V
$V_{EBO}$	emitter-base voltage	open collector		-	5	V
I <sub>C</sub>	collector current			-	100	mA
I <sub>CM</sub>	peak collector current	$single \ pulse; \\ t_p \leq 1 \ ms$		-	200	mA
I <sub>BM</sub>	peak base current	single pulse; $t_p \le 1 \text{ ms}$		-	100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	[1][2]	-	250	mW
			[3][2]	-	590	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	+150	°C
$T_{stg}$	storage temperature			-65	+150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

<sup>[2]</sup> Reflow soldering is the only recommended soldering method.

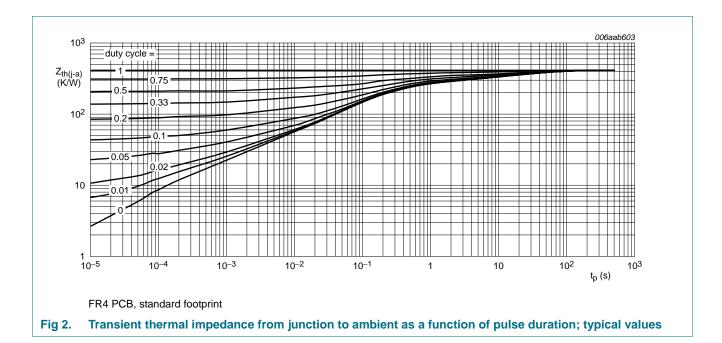
<sup>[3]</sup> Device mounted on an FR4 PCB, single-sided copper, mounting pad for collector 1 cm<sup>2</sup>.

#### 6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from	in free air	[1][2]	-	500	K/W
	junction to ambient		[3][2]	-	212	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Reflow soldering is the only recommended soldering method.
- [3] Device mounted on an FR4 PCB, single-sided copper, mounting pad for collector 1 cm<sup>2</sup>.



#### **7**. **Characteristics**

Table 8. **Characteristics** 

 $T_{amb} = 25$  °C unless otherwise specified.

Parameter	Conditions	Min	Typ	May	Unit
raiailletel	Conditions	IVIIII	ıyp	IVIAX	Ullit
	$V_{CB} = 30 \text{ V}; I_{E} = 0 \text{ A}$	-	-	100	nA
cut-off current	$V_{CB} = 30 \text{ V; } I_E = 0 \text{ A;}$ $T_j = 150 ^{\circ}\text{C}$	-	-	5	μΑ
emitter-base cut-off current	$V_{EB} = 4 \text{ V}; I_{C} = 0 \text{ A}$	-	-	100	nA
DC current gain	$V_{CE} = 6 \text{ V}; I_{C} = 1 \text{ mA}$				
2PC4617QMB		120	-	270	
2PC4617RMB		180	-	390	
collector-emitter saturation voltage	$I_C = 50 \text{ mA}; I_B = 5 \text{ mA}$	<u>[1]</u> _	-	200	mV
transition frequency	$V_{CE} = 12 \text{ V}; I_{C} = 2 \text{ mA};$ f = 100 MHz	100	-	-	MHz
collector capacitance	$V_{CB} = 12 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	1.5	pF
	cut-off current DC current gain 2PC4617QMB 2PC4617RMB collector-emitter saturation voltage transition frequency	$ \begin{array}{lll} \mbox{collector-base} & \mbox{V}_{CB} = 30 \ \mbox{V}; \ \mbox{I}_{E} = 0 \ \mbox{A} \\ \mbox{V}_{CB} = 30 \ \mbox{V}; \ \mbox{I}_{E} = 0 \ \mbox{A}; \\ \mbox{V}_{CB} = 30 \ \mbox{V}; \ \mbox{I}_{E} = 0 \ \mbox{A}; \\ \mbox{T}_{j} = 150 \ \mbox{°C} \\ \mbox{emitter-base} & \mbox{V}_{EB} = 4 \ \mbox{V}; \ \mbox{I}_{C} = 0 \ \mbox{A} \\ \mbox{DC current gain} & \mbox{V}_{CE} = 6 \ \mbox{V}; \ \mbox{I}_{C} = 1 \ \mbox{mA} \\ \mbox{2PC4617QMB} & \mbox{2PC4617RMB} \\ \mbox{collector-emitter} & \mbox{I}_{C} = 50 \ \mbox{mA}; \ \mbox{I}_{B} = 5 \ \mbox{mA} \\ \mbox{transition frequency} & \mbox{V}_{CE} = 12 \ \mbox{V}; \ \mbox{I}_{C} = 2 \ \mbox{mA}; \\ \mbox{f} = 100 \ \mbox{MHz} \\ \mbox{collector capacitance} & \mbox{V}_{CB} = 12 \ \mbox{V}; \ \mbox{I}_{E} = i_{e} = 0 \ \mbox{A}; \\ \mbox{f} = 100 \ \mbox{MHz} \\ \mbox{collector capacitance} & \mbox{V}_{CB} = 12 \ \mbox{V}; \ \mbox{I}_{E} = i_{e} = 0 \ \mbox{A}; \\ \mbox{f} = 100 \ \mbox{MHz} \\ \mbox{collector capacitance} & \mbox{V}_{CB} = 12 \ \mbox{V}; \ \mbox{I}_{E} = i_{e} = 0 \ \mbox{A}; \\ \mbox{f} = 100 \ \mbox{MHz} \\ \mbox{collector capacitance} & \mbox{V}_{CB} = 12 \ \mbox{V}; \ \mbox{I}_{E} = i_{e} = 0 \ \mbox{A}; \\ \mbox{f} = 100 \ \mbox{MHz} \\ \mbox{collector capacitance} & \mbox{V}_{CB} = 12 \ \mbox{V}; \ \mbox{I}_{E} = i_{e} = 0 \ \mbox{A}; \\ \mbox{f} = 100 \ \mbox{MHz} \\ \mbox{collector capacitance} & \mbox{C}_{CB} = 12 \ \mbox{V}; \mbox{I}_{C} = 1 \ \mbox{M}; \\ \mbox{collector capacitance} & \mbox{C}_{CB} = 12 \ \mbox{V}; \mbox{I}_{E} = i_{e} = 0 \ \mbox{A}; \\ \mbox{collector capacitance} & \mbox{C}_{CB} = 12 \ \mbox{V}; \mbox{R}_{E} = 12 \ \mbox{M}; \\ \mbox{collector capacitance} & \mbox{C}_{CB} = 12 \ \mbox{V}; \mbox{R}_{E} = 12 \ \mbox{C}_{E} = 12 \ \mbox$	$ \begin{array}{c} \text{collector-base} \\ \text{cut-off current} \\ \end{array} \begin{array}{c} V_{CB} = 30 \text{ V; } I_E = 0 \text{ A} \\ \\ V_{CB} = 30 \text{ V; } I_E = 0 \text{ A; } \\ \\ T_j = 150 \text{ °C} \\ \end{array} \\ \end{array} \begin{array}{c} \text{emitter-base} \\ \text{cut-off current} \\ \end{array} \begin{array}{c} V_{EB} = 4 \text{ V; } I_C = 0 \text{ A} \\ \\ \text{cut-off current} \\ \end{array} \\ \begin{array}{c} DC \text{ current gain} \\ \\ 2PC4617QMB \\ \\ 2PC4617RMB \\ \end{array} \begin{array}{c} V_{CE} = 6 \text{ V; } I_C = 1 \text{ mA} \\ \\ \\ 2PC4617RMB \\ \end{array} \begin{array}{c} 120 \\ \\ 180 \\ \end{array} \\ \end{array} \\ \begin{array}{c} Collector-emitter \\ \text{saturation voltage} \\ \end{array} \begin{array}{c} I_C = 50 \text{ mA; } I_B = 5 \text{ mA} \\ \\ I_C = 100 \text{ MHz} \\ \end{array} \begin{array}{c} 100 \\ \\ I_C = 100 \text{ MHz} \\ \end{array} \\ \end{array} \\ \begin{array}{c} Collector \text{ capacitance} \\ V_{CB} = 12 \text{ V; } I_C = 2 \text{ mA; } \\ I_C = 100 \text{ MHz} \\ \end{array} \\ \end{array} \\ \begin{array}{c} I_C = 12 \text{ V; } I_C = 2 \text{ mA; } \\ I_C = 12 \text{ V; } I_C = 2 \text{ V; } I_C = 2 \text{ V; } \\ I_C = 12 \text{ V; } I_C = 2 \text{ V; } \\ I_C = 12 \text{ V; } I_C = 2 \text{ V; } \\ I_C = 12  $		

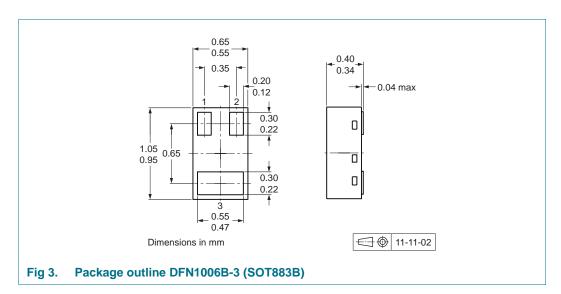
<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

#### **Test information** 8.

## 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

#### **Package outline** 9.



2PC4617XMB SER

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## 10. Packing information

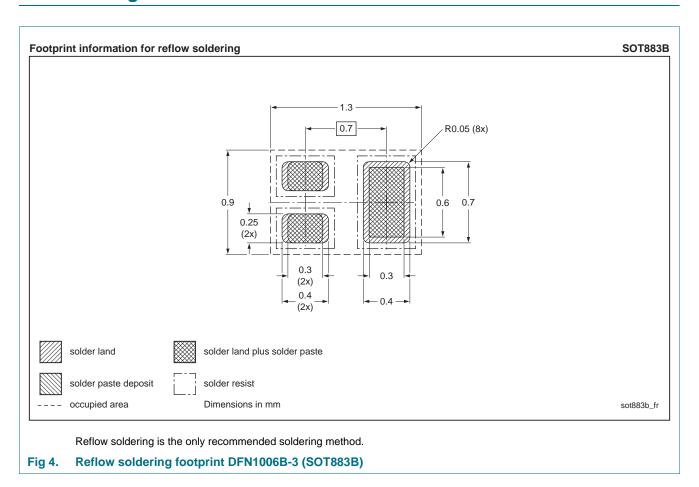
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number Package Description		Description	Packing quantity
			10000
2PC4617xMB series	DFN1006B-3 (SOT883B)	2 mm pitch, 8 mm tape and reel	-315

<sup>[1]</sup> For further information and the availability of packing methods, see Section 14.

## 11. Soldering



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## 12. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
2PC4617XMB_SER v.1	20120326	Product data sheet	-	-

## 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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